

WHAT IS CLAIMED IS:

1. A heat-dissipating fan module of an electronic apparatus, comprising:
 - a casing having an opening, said opening having a guiding device along an edge thereof; and
 - a heat-dissipating fan fixed into one side of said casing and correspondingly disposed on said opening.
2. The heat-dissipating fan module according to claim 1 wherein said guiding device is a metal material disposed on said edge portion of said opening, extended from said edge of said opening, and inclined toward the axis of the opening.
3. The heat-dissipating fan module according to claim 1 wherein said casing and said guiding device are disposed to form a particular angle.
4. The heat-dissipating fan module according to claim 3 wherein said particular angle is substantially 5 to 90 degrees.
5. The heat-dissipating fan module according to claim 1 wherein said heat-dissipating fan is a fan without a frame.
6. The heat-dissipating fan module according to claim 1 wherein said casing further comprises a reticular portion integrally formed therewith and disposed at the corresponding position of said opening.
7. The heat-dissipating fan module according to claim 1 further comprising a reticular plate, wherein said reticular plate is separably fixed to one side of said casing for covering said opening.
8. The heat-dissipating fan module according to claim 1 wherein said electronic apparatus is a power supply.
9. A heat-dissipating fan module of an electronic apparatus, comprising:
 - a casing having an opening;

a guiding device separably disposed around an edge of said opening; and
a heat-dissipating fan disposed on one side of said casing and
correspondingly disposed on said opening.

10. The heat-dissipating fan module according to claim 9 wherein said casing further comprises a reticular portion integrally formed therewith and disposed at the corresponding position of said opening.
11. The heat-dissipating fan module according to claim 9 further comprising a reticular plate, wherein said reticular plate is separably fixed to one side of said casing for covering said opening.
12. The heat-dissipating fan module according to claim 11 wherein said reticular plate is made of one selected from a group consisting of metal material, paper material and plastic material.
13. The heat-dissipating fan module according to claim 11 wherein said guiding device is separated from said reticular plate.
14. The heat-dissipating fan module according to claim 11 wherein said guiding device is integrally formed with said reticular plate.
15. The heat-dissipating fan module according to claim 9 wherein said casing and said guiding device are disposed to form a particular angle.
16. The heat-dissipating fan module according to claim 15 wherein said particular angle is substantially 5 to 90 degrees.
17. The heat-dissipating fan module according to claim 9 wherein said heat-dissipating fan is a fan without a frame.
18. The heat-dissipating fan module according to claim 9 wherein said electronic apparatus is a power supply.